8-bit bus switch with 4-bit output enables Rev. 2 — 15 December 2011

Product data sheet

1. **General description**

The 74CBTLV3244 is a dual 4-pole, single-throw bus switch. The device features two output enable inputs (nOE) that each control four switch channels. The switches are disabled when the associated nOE input is HIGH. Schmitt trigger action at control inputs makes the circuit tolerant of slower input rise and fall times. This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. **Features and benefits**

- Supply voltage range from 2.3 V to 3.6 V
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8-B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
- **5** Ω switch connection between two ports
- Rail to rail switching on data I/O ports
- CMOS low power consumption
- Latch-up performance exceeds 250 mA per JESD78B Class I level A
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



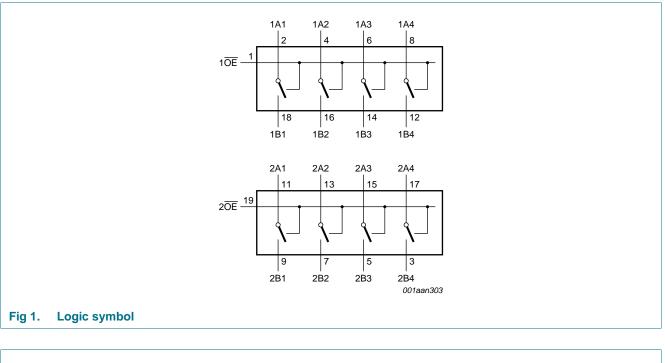
8-bit bus switch with 4-bit output enables

Ordering information 3.

Type number	Package						
	Temperature range	Name	Description	Version			
74CBTLV3244DS	–40 °C to +125 °C	SSOP20[1]	plastic shrink small outline package; 20 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT724-1			
74CBTLV3244PW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1			
74CBTLV3244BQ	–40 °C to +125 °C	DHVQFN20	plastic dual-in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-1			

[1] Also known as QSOP20 package

Functional diagram 4.



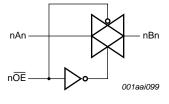


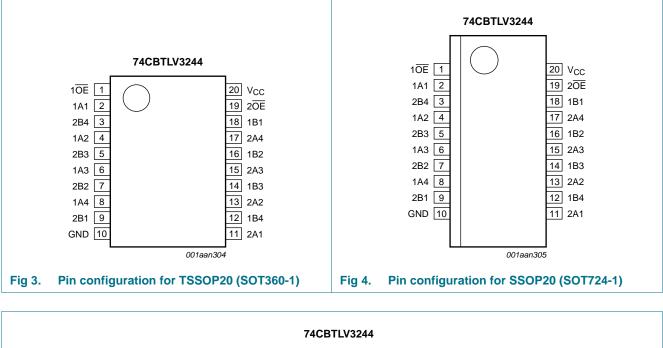
Fig 2. Logic diagram (one switch)

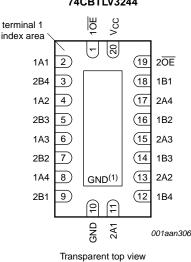
74CBTLV3244 **Product data sheet**

8-bit bus switch with 4-bit output enables

5. Pinning information

5.1 Pinning





(1) This is not a supply pin. The substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad. However, if it is soldered, the solder land should remain floating or be connected to GND.



74CBTLV3244

8-bit bus switch with 4-bit output enables

5.2 Pin description

Table 2. Pin d	escription	
Symbol	Pin	Description
1 <u>0E</u> , 2 <u>0E</u>	1, 19	output enable input (active LOW)
1A1 to 1A4	2, 4, 6, 8	data input/output (A port)
2B1 to 2B4	9, 7, 5, 3	data input/output (A port)
GND	10	ground (0 V)
2A1 to 2A4	11, 13, 15, 17	data input/output (B port)
1B1 to 1B4	18, 16, 14, 12	data input/output (B port)
V _{CC}	20	positive supply voltage

6. Functional description

Table 3. Function selection^[1]

Input nOE	Input/output
nOE	nAn, nBn
L	nAn = nBn
Н	Z

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

					-
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
V _{SW}	switch voltage	enable and disable mode	<u>[1]</u> –0.5	$V_{CC} + 0.5$	V
I _{IK}	input clamping current	V _I < -0.5 V	-50	-	mA
I _{SK}	switch clamping current	V _I < -0.5 V	-50	-	mA
I _{SW}	switch current	$V_{SW} = 0 V \text{ to } V_{CC}$	-	±128	mA
I _{CC}	supply current		-	+100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$	[2] _	500	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SSOP20 and TSSOP20 packages: above 60 °C the value of P_{tot} derates linearly at 5.5 mW/K.
 For DHVQFN20 packages: above 60 °C the value of P_{tot} derates linearly at 4.5 mW/K.

8-bit bus switch with 4-bit output enables

8. Recommended operating conditions

Table 5.	Recommended operating condition	ons			
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		2.3	3.6	V
VI	input voltage		0	3.6	V
V _{SW}	switch voltage	enable and disable mode	0	V _{CC}	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 2.3 V to 3.6 V	<u>[1]</u> _	200	ns/V

[1] Applies to control signal levels.

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions voltages are referenced to GND (ground = 0 V).

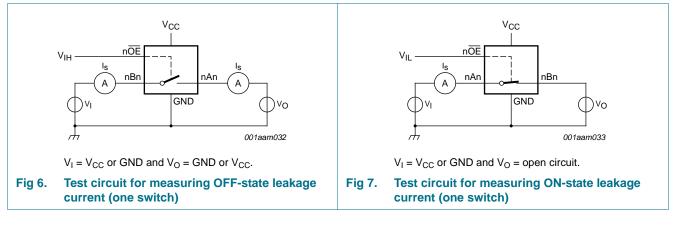
Symbol	Parameter	Conditions	T _{amb} =	–40 °C to	+85 °C	$T_{amb} = -40 \circ$	C to +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	1
V _{IH}	HIGH-level	V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
	input voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL}		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
	voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.9	-	0.9	V
I _I	input leakage current	pin n \overline{OE} ; V ₁ = GND to V _{CC} ; V _{CC} = 3.6 V	-	-	±1	-	±20	μA
I _{S(OFF)}	OFF-state leakage current	V_{CC} = 3.6 V; see <u>Figure 6</u>	-	-	±1	-	±20	μΑ
I _{S(ON)}	ON-state leakage current	V_{CC} = 3.6 V; see <u>Figure 7</u>	-	-	±1	-	±20	μΑ
I _{OFF}	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V}$	-	-	±10	-	±50	μΑ
I _{CC}	supply current		-	-	10	-	50	μA
ΔI_{CC}	additional supply current	pin $\overline{\text{OE}}$; V _I = V _{CC} - 0.6 V; V _{SW} = GND or V _{CC} ; V _{CC} = 3.6 V	[2] _	-	300	-	2000	μA
Cl	input capacitance	pin n \overline{OE} ; V _{CC} = 3.3 V; V _I = 0 V to 3.3 V	-	0.9	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance	V_{CC} = 3.3 V; V_{I} = 0 V to 3.3 V	-	5.2	-	-	-	pF
$C_{S(ON)}$	ON-state capacitance	V_{CC} = 3.3 V; V_{I} = 0 V to 3.3 V	-	14.3	-	-	-	pF

[1] All typical values are measured at T_{amb} = 25 °C.

[2] One input at 3 V, other inputs at V_{CC} or GND.

8-bit bus switch with 4-bit output enables

9.1 Test circuits



9.2 ON resistance

Table 7.Resistance Ron

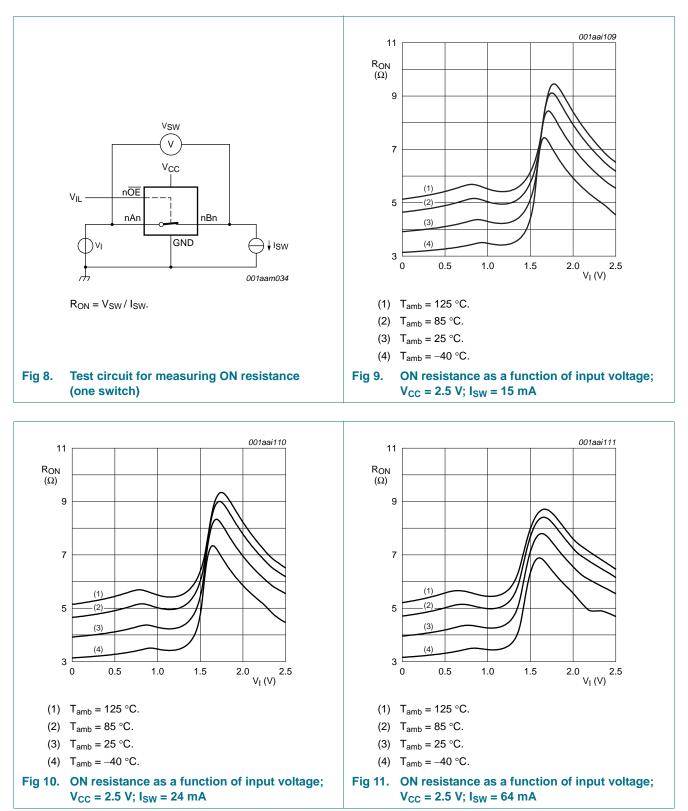
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

Symbol Parameter		Conditions	T _{amb} =	–40 °C to	+85 °C	T _{amb} = -40 °C to +125 °C		Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
	V _{CC} = 2.3 V to 2.7 V; [2] see <u>Figure 9</u> to <u>Figure 11</u>							
		$I_{SW} = 64 \text{ mA}; V_{I} = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω
		I_{SW} = 15 mA; V_{I} = 1.7 V	-	8.4	40	-	60.0	Ω
		$V_{CC} = 3.0 V$ to 3.6 V; see <u>Figure 12</u> to <u>Figure 14</u>						
		$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	4.0	7.0	-	11.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	4.0	7.0	-	11.0	Ω
		I_{SW} = 15 mA; V_{I} = 2.4 V	-	6.2	15	-	25.5	Ω

[1] Typical values are measured at T_{amb} = 25 $^\circ C$ and nominal $V_{CC}.$

[2] Measured by the voltage drop between the A and B terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

8-bit bus switch with 4-bit output enables



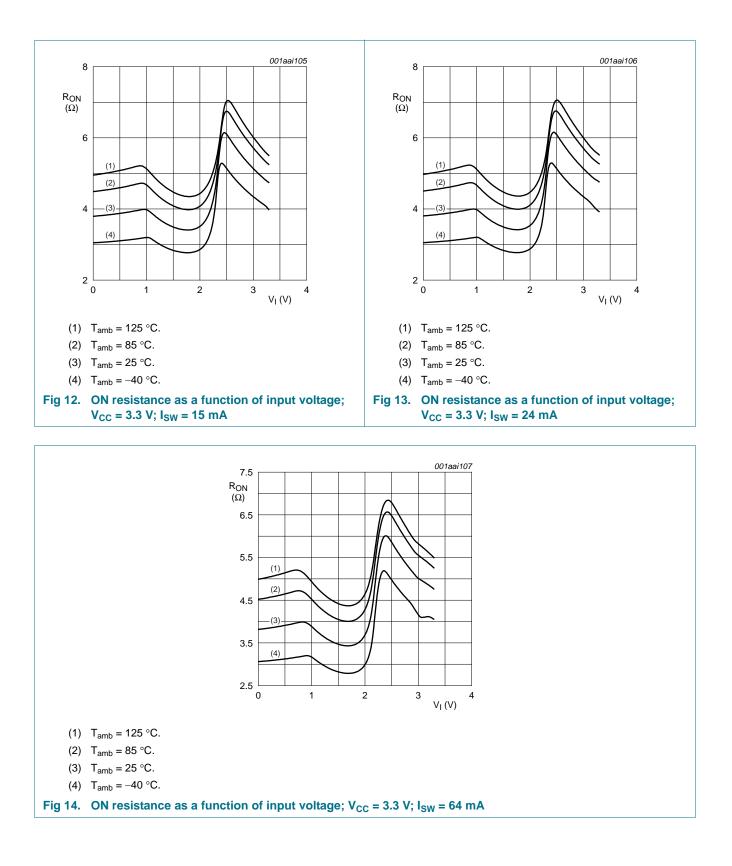
9.3 ON resistance test circuit and graphs

74CBTLV3244 Product data sheet

7 of 18

74CBTLV3244

8-bit bus switch with 4-bit output enables



8-bit bus switch with 4-bit output enables

10. Dynamic characteristics

Table 8. Dynamic characteristics

GND = 0 V; for test circuit see Figure 17

Symbol	Parameter	Conditions		T _{amb} = -40 °C to +85 °C			$T_{amb} = -40$ °	°C to +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	-
t _{pd}	propagation delay	nAn to nBn or nBn to nAn; see <u>Figure 15</u>	<u>[2][3]</u>						
		V_{CC} = 2.3 V to 2.7 V		-	-	0.13	-	0.20	ns
		V_{CC} = 3.0 V to 3.6 V		-	-	0.20	-	0.31	ns
t _{en} enable	enable time	n <mark>OE</mark> to nAn or nBn; see <u>Figure 16</u>	<u>[4]</u>						
		V_{CC} = 2.3 V to 2.7 V		1.0	3.0	5.0	1.0	7.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	2.6	4.3	1.0	6.0	ns
t _{dis}	disable time	nOE to nAn or nBn; see <u>Figure 16</u>	[5]						
		V_{CC} = 2.3 V to 2.7 V		1.0	2.6	5.5	1.0	7.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	3.2	5.5	1.0	7.5	ns

[1] All typical values are measured at T_{amb} = 25 $^\circ C$ and at nominal $V_{CC}.$

[2] The propagation delay is the calculated RC time constant of the on-state resistance of the switch and the load capacitance, when driven by an ideal voltage source (zero output impedance).

 $[3] \quad t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}.$

[4] t_{en} is the same as t_{PZH} and t_{PZL} .

[5] t_{dis} is the same as t_{PHZ} and t_{PLZ} .

11. Waveforms

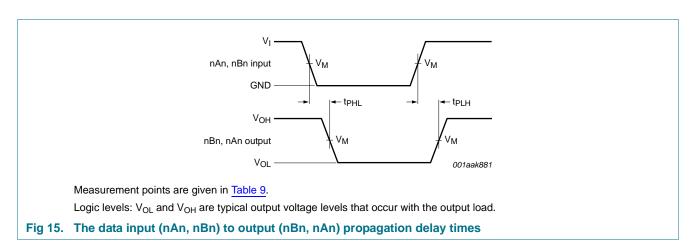


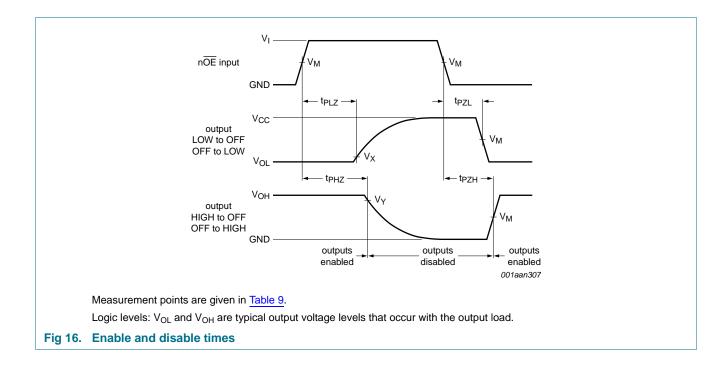
Table 9. Measurement points

Supply voltage	Input			Output	Output		
V _{CC}	V _M	VI	$t_r = t_f$	V _M	V _X	V _Y	
2.3 V to 2.7 V	0.5V _{CC}	V _{CC}	\leq 2.0 ns	$0.5V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V	
3.0 V to 3.6 V	0.5V _{CC}	V _{CC}	\leq 2.0 ns	$0.5V_{CC}$	V _{OL} + 0.3 V	$V_{OH} - 0.3 \ V$	

74CBTLV3244

74CBTLV3244

8-bit bus switch with 4-bit output enables



74CBTLV3244

8-bit bus switch with 4-bit output enables

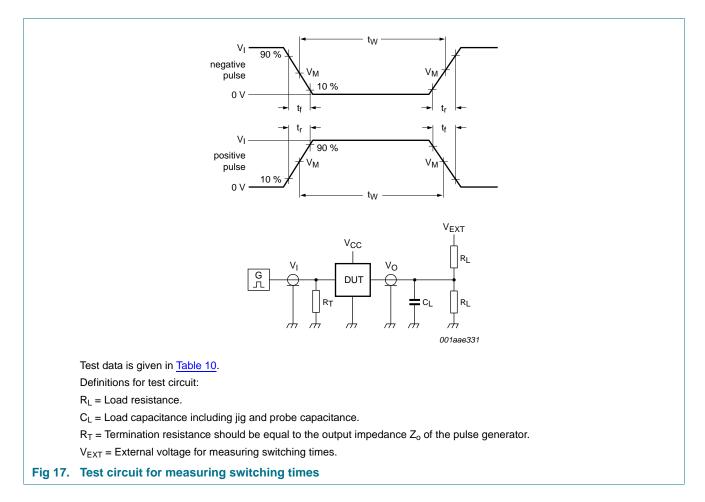


Table 10. Test data

Supply voltage	Load	V _{EXT}			
V _{cc}	CL	RL	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
2.3 V to 2.7 V	30 pF	500 Ω	open	GND	2V _{CC}
3.0 V to 3.6 V	50 pF	500 Ω	open	GND	2V _{CC}

74CBTLV3244

8-bit bus switch with 4-bit output enables

12. Package outline

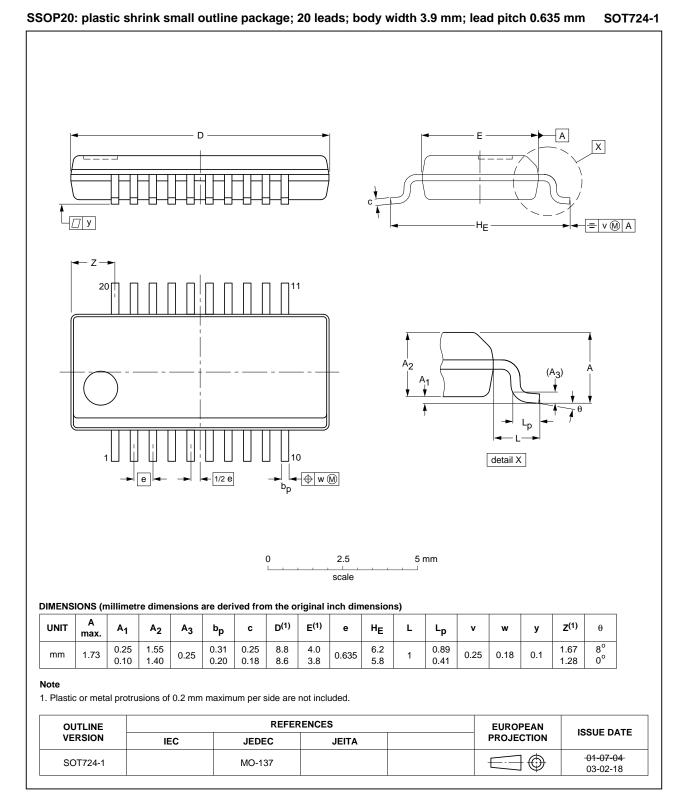


Fig 18. Package outline SOT724-1 (SSOP20)

All information provided in this document is subject to legal disclaimers.

74CBTLV3244

© NXP B.V. 2011. All rights reserved.

8-bit bus switch with 4-bit output enables

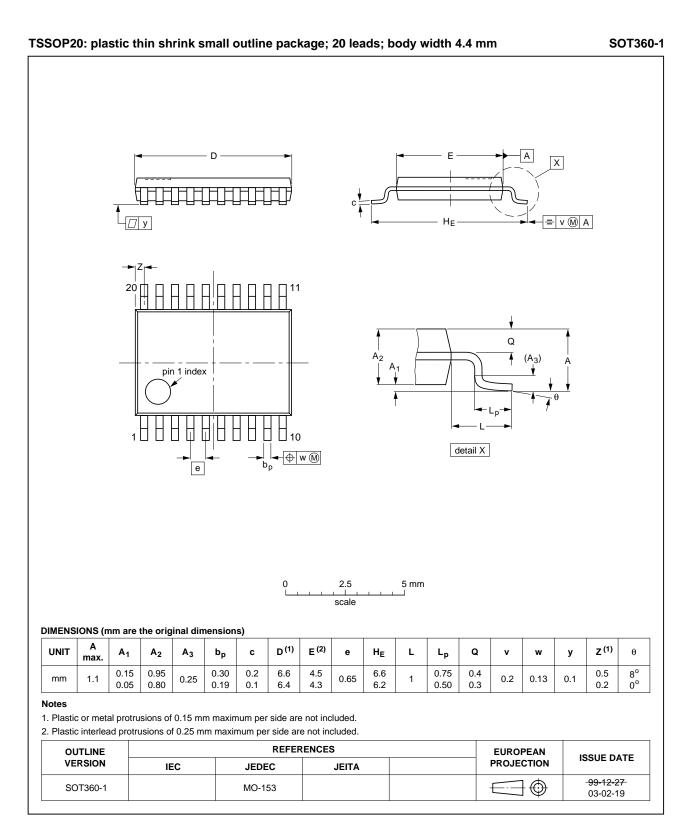
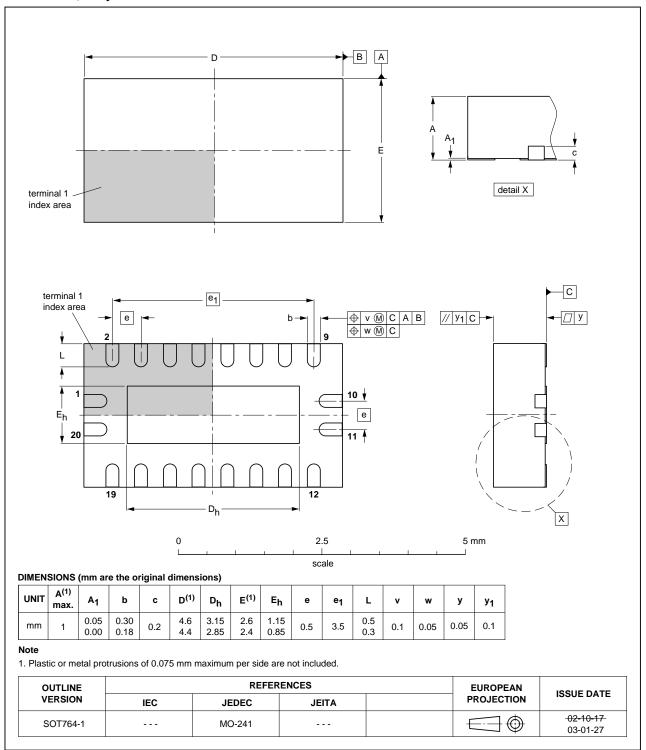


Fig 19. Package outline SOT360-1 (TSSOP20)

All information provided in this document is subject to legal disclaimers.

74CBTLV3244

8-bit bus switch with 4-bit output enables



DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 20. Package outline SOT764-1 (DHVQFN20)

74CBTLV3244

8-bit bus switch with 4-bit output enables

13. Abbreviations

Acronym CDM CMOS	Description Charged Device Model
-	Charged Device Model
CMOS	
	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model

14. Revision history

Table 12.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74CBTLV3244 v.2	20111215	Product data sheet	-	74CBTLV3244 v.1		
Modifications: • Legal pages updated.						
74CBTLV3244 v.1	20101228	Product data sheet	-	-		

8-bit bus switch with 4-bit output enables

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

15.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

15.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

74CBTLV3244

All information provided in this document is subject to legal disclaimers.

8-bit bus switch with 4-bit output enables

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

16. Contact information

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

8-bit bus switch with 4-bit output enables

17. Contents

1	General description	1
2	Features and benefits	1
3	Ordering information	2
4	Functional diagram	2
5	Pinning information	3
5.1	Pinning	3
5.2	Pin description	4
6	Functional description	4
7	Limiting values	4
8	Recommended operating conditions	5
9	Static characteristics	5
9.1	Test circuits	6
9.2	ON resistance	-
9.3	ON resistance test circuit and graphs	7
10	Dynamic characteristics	9
11	Waveforms	9
12	Package outline	12
13	Abbreviations	15
14	Revision history	15
15	Legal information	16
15.1		16
15.2	Definitions	16
15.3		16
15.4	Trademarks	17
16	Contact information	17
17	Contents	18

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2011.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 15 December 2011 Document identifier: 74CBTLV3244